

# CP247-2N6284 NPN - Darlington Transistor Die 20 Amp, 120 Volt

The CP247-2N6284 is a silicon NPN Darlington power transistor designed for high current applications.

	MECHANICAL SP
	Die Size
	Die Thickness
	Base Bonding Pad
	Emitter Bonding Pa
	Top Side Metalizat
	Back Side Metaliza
	Scribe Alley Width
	Wafer Diameter
BACKSIDE COLLECTOR R1	Gross Die Per Wat
MAXIMUM RATINGS: (T <sub>A</sub> =25°C) Collector-Base Voltage	S
Collector-Emitter Voltage	
Emitter-Base Voltage	
Continuous Collector Current	
Peak Collector Current	

### MECHANICAL SPECIFICATIONS:

Die Size	211 x 211 MILS
Die Thickness	12.5 MILS
Base Bonding Pad Size	49 x 41 MILS
Emitter Bonding Pad Size	60 x 50 MILS
Top Side Metalization	AI – 50,000Å
Back Side Metalization	Ti/Ni/Ag – 1,000Å/6,000Å/10,000Å
Scribe Alley Width	4 MILS
Wafer Diameter	4 INCHES
Gross Die Per Wafer	246
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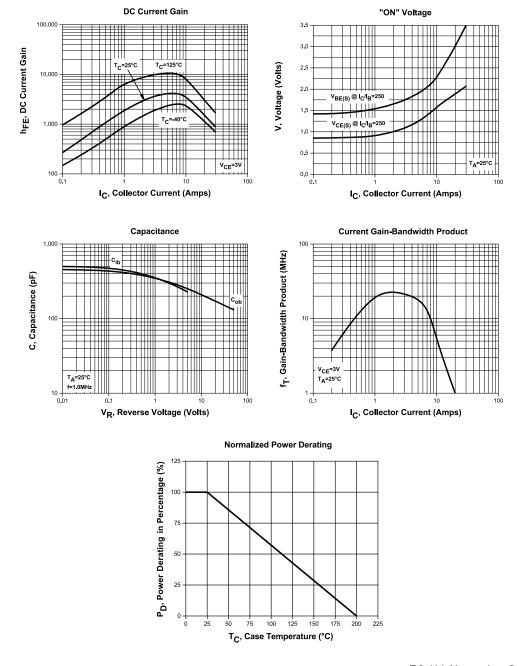
	ATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Collector-Bas	se Voltage	V <sub>CBO</sub>	100	V
Collector-Em	itter Voltage	V <sub>CEO</sub>	100	V
Emitter-Base	Voltage	V <sub>EBO</sub>	5.0	V
Continuous C	Collector Current	۱ <sub>C</sub>	20	А
Peak Collector Current		<sup>I</sup> CM	40	А
Continuous E	Base Current	Ι <sub>Β</sub>	0.5	А
Operating an	d Storage Junction Temperature	TJ, Tstg	-65 to +200	°C
	L CHARACTERISTICS: (T <sub>A</sub> =25°C u			
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
ICEX	V <sub>CE</sub> =100V, V <sub>EB</sub> =1.5V		0.5	mA
ICEO	V <sub>CE</sub> =50V		1.0	mA
I <sub>EBO</sub>	V <sub>EB</sub> =5.0V		2.0	mA
BVCEO	I <sub>C</sub> =100mA	100		V
V <sub>CE(SAT)</sub>	I <sub>C</sub> =10A, I <sub>B</sub> =40mA		2.0	V
V <sub>CE(SAT)</sub>	I <sub>C</sub> =20A, I <sub>B</sub> =200mA		3.0	V
V <sub>BE(SAT)</sub>	I <sub>C</sub> =20A, I <sub>B</sub> =200mA		4.0	V
V <sub>BE(ON)</sub>	V <sub>CE</sub> =3.0V, I <sub>C</sub> =10A		2.8	V
h <sub>FE</sub>	V <sub>CE</sub> =3.0V, I <sub>C</sub> =10A	750	18K	
h <sub>FE</sub>	V <sub>CE</sub> =3.0V, I <sub>C</sub> =20A	100		
h <sub>fe</sub>	V <sub>CE</sub> =3.0V, I <sub>C</sub> =10A, f=1.0kHz	300		
f <sub>T</sub>	V <sub>CE</sub> =3.0V, I <sub>C</sub> =10A, f=1.0MHz	4.0		MHz
Cob	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=100kHz		400	pF

R0 (11-November 2019)

# **CP247-2N6284** Typical Electrical Characteristics



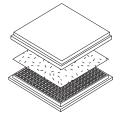
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# BARE DIE PACKING OPTIONS



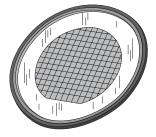


## BARE DIE IN TRAY (WAFFLE) PACK

- CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)
- CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-<u>PART NUMBER</u>-CM)

## **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



# SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked. (example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

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## **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**

#### **PRODUCT SUPPORT**

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

#### **REQUESTING PRODUCT PLATING**

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### CONTACT US

#### **Corporate Headquarters & Customer Support Team**

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824 Support Team Fax: (631) 435-3388 www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

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# Product End of Life Notification

PDN ID:	PDN01184
Notification Date:	8/13/21
Last Buy Date:	2/13/22
Last Shipment Date	8/13/22

Summary:CP247 and CP287 die processes are discontinued and now classified as End Life (EOL).

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

#### \* All Plating types (PBFREE,TIN/LEAD) for each item listed are included in this notice.

Central Part Number	Suggested Replacement
CP247-2N6284-CT	N/A
CP287-MJE13007-CT	N/A

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.